5413969-2 - ACTIVE

TE Internal #: 5413969-2 BNC RF Interface, Jack, 50 Ω, Bayonet, 4 GHz Operating Frequency, Cable-to-Board, 1 Position, Printed Circuit Board, Board Mount

View on TE.com >



Connectors > RF Connectors > Coax Connectors > BNC Vertical Jack RF Connector, 50 Ohm, Bayonet Coupling Mechanism



RF Interface: BNC

RF Connector Style: Jack

RF Connector Mated Outer Diameter (Approximate): 14.53 mm [.572 in]

Impedance: 50Ω

RF Connector Coupling Mechanism: Bayonet

All BNC Vertical Jack RF Connector, 50 Ohm, Bayonet Coupling Mechanism (32)

Features

Product Type Features

| RF Interface | BNC |
|-----------------------------------|-----------------------|
| RF Connector Style | Jack |
| Connector System | Cable-to-Board |
| Sealable | No |
| Connector & Contact Terminates To | Printed Circuit Board |
| Configuration Features | |
| PCB Mount Orientation | Vertical |
| Number of Positions | 1 |
| Number of Coaxial Contacts | 1 |
| Electrical Characteristics | |
| Impedance | 50 Ω |
| Body Features | |
| Body Material | Zinc |

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| Body Plating Material | Tin |
|---|-----------------------|
| Contact Features | |
| RF Connector Center Contact Underplating Material | Nickel |
| | 1080 µin |
| RF Connector Center Contact Plating Material | Gold |
| RF Connector Center Contact Material | Beryllium Copper |
| Termination Features | |
| Termination Post & Tail Length | 3.3 mm[.13 in] |
| Termination Method to Printed Circuit Board | Through Hole - Solder |
| Mechanical Attachment | |
| PCB Mount Retention | Without |
| RF Connector Coupling Mechanism | Bayonet |
| Connector Mounting Type | Board Mount |
| RF Contact Captivation Method | Mechanical |
| Detent | With |
| Dimensions | |

Profile Height from PCB

20.57 mm[.81 in]

| RF Connector Mated Outer Diameter (Approximate) | 14.53 mm[.572 in] |
|---|---------------------------|
| Usage Conditions | |
| Insulation Option | Uninsulated |
| Operating Temperature Range | -55 – 85 °C[-67 – 185 °F] |
| Operation/Application | |
| Operating Frequency | 4 GHz |
| Packaging Features | |
| Packaging Method | Carton |
| Other | |
| Grade | Commercial |
| Dielectric Material | PTFE |
| | |

Product Compliance

For compliance documentation, visit the product page on TE.com>

BNC RF Interface, Jack, 50 Ω, Bayonet, 4 GHz Operating Frequency, Cable-to-Board, 1 Position, Printed Circuit Board, Board Mount



| EU RoHS Directive 2011/65/EU | Compliant with Exemptions |
|---|--|
| EU ELV Directive 2000/53/EC | Compliant with Exemptions |
| China RoHS 2 Directive MIIT Order No 32, 2016 | Restricted Materials Above Threshold |
| EU REACH Regulation (EC) No. 1907/2006 | Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) SVHC > Threshold: Pb (.6% in Component Part) Article Safe Usage Statements: Do not eat, drink or smoke when using this product. Wash thoroughly after handling. Recycle if possible and dispose of the article by following all applicable governmental regulations relevant to your geographic location. |
| Halogen Content | Low Bromine/Chlorine - Br and Cl < 900 ppm per homogenous material. Also BFR /CFR/PVC Free |
| Solder Process Canability | Wave solder capable to 265° C |

Solder Process Capability

Wave solder capable to 265°C

Product Compliance Disclaimer

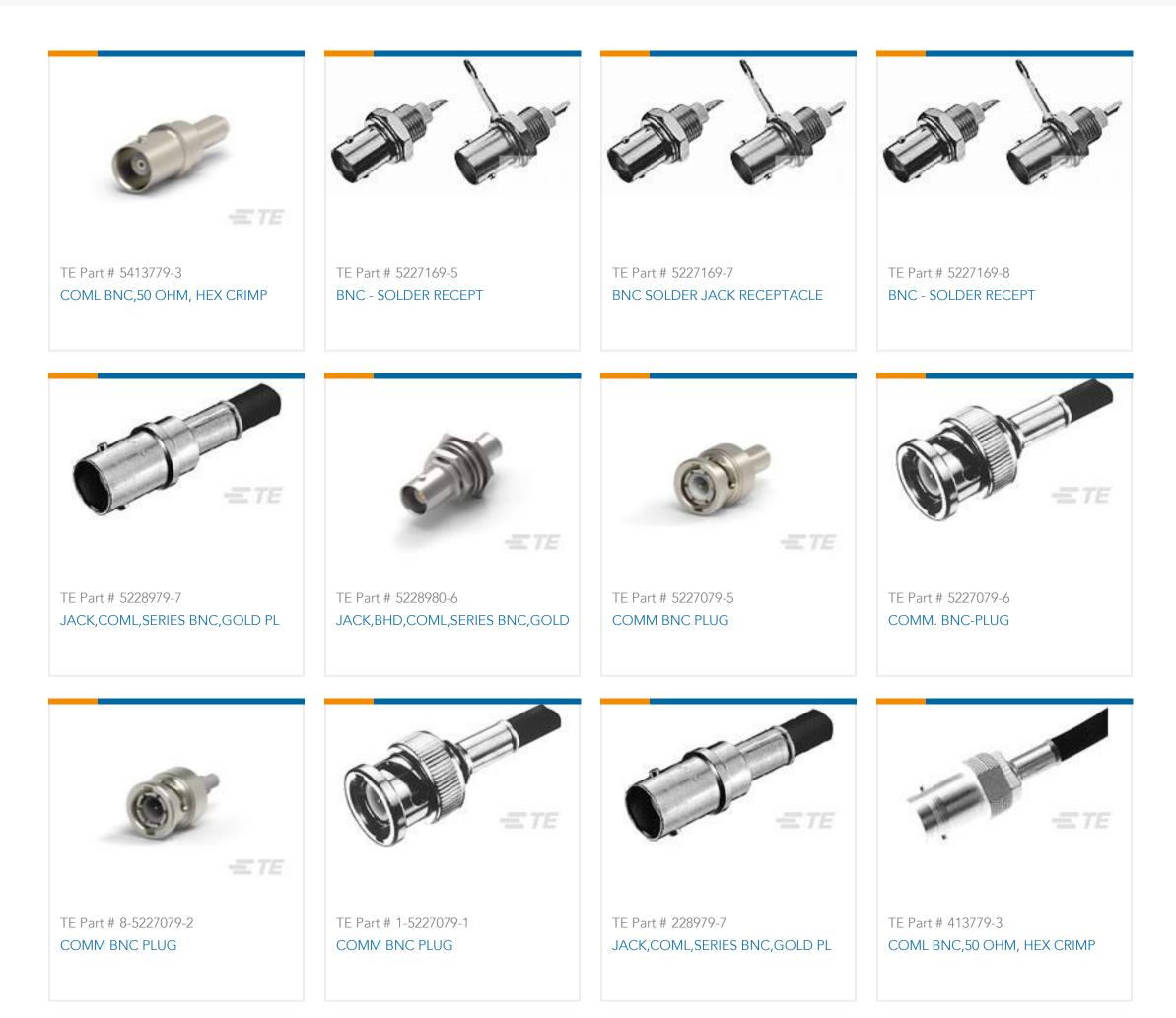
This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts



BNC RF Interface, Jack, 50 Ω, Bayonet, 4 GHz Operating Frequency, Cable-to-Board, 1 Position, Printed Circuit Board, Board Mount







Customers Also Bought



Documents

BNC RF Interface, Jack, 50 Ω , Bayonet, 4 GHz Operating Frequency, Cable-to-Board, 1 Position, Printed Circuit Board, Board Mount



Product Drawings JACK,PCB,VERT,COMMERCIAL BNC

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_5413969-2_A.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_5413969-2_A.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_5413969-2_A.3d_stp.zip

English

By downloading the CAD file I accept and agree to the Terms and Conditions of use

Datasheets & Catalog Pages BNC Connectors

English

Product Specifications Product Specification

English

Product Environmental Compliance MD_5413969-2_04222014154_dmtec

English

MD_5413969-2_04222014154_dmtec

English

Instruction Sheets Instruction Sheet (U.S.)

English